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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/823,729	04/14/2004	Takashi Watanabe	042341	5344
38834 7	590 09/07/2005	•	EXAMINER	
WESTERMAN, HATTORI, DANIELS & ADRIAN, LLP			VU, DAVID	
1250 CONNEC	CTICUT AVENUE, NW			
SUITE 700	•		ART UNIT	PAPER NUMBER
WASHINGTO	N, DC 20036	•	2818	

DATE MAILED: 09/07/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			SI
	Application No.	Applicant(s)	
	10/823,729	WATANABE ET AL.	
Office Action Summary	Examiner	Art Unit	
	DAVID VU	2818	
The MAILING DATE of this communication of Period for Reply	appears on the cover sheet w	ith the correspondence address	••
A SHORTENED STATUTORY PERIOD FOR REI THE MAILING DATE OF THIS COMMUNICATIO - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a - If NO period for reply is specified above, the maximum statutory per - Failure to reply within the set or extended period for reply will, by sta Any reply received by the Office later than three months after the may earned patent term adjustment. See 37 CFR 1.704(b).	N. 1.136(a). In no event, however, may a reply within the statutory minimum of thi iod will apply and will expire SIX (6) MOI tute, cause the application to become A	reply be timely filed ty (30) days will be considered timely. NTHS from the mailing date of this communic BANDONED (35 U.S.C. § 133).	eation.
Status			
1) Responsive to communication(s) filed on 22	<u> 2 June 2005</u> .		
2a)☐ This action is FINAL . 2b)⊠ T	his action is non-final.		
3) Since this application is in condition for allow	wance except for formal mat	ters, prosecution as to the merit	ts is
closed in accordance with the practice under	er Ex parte Quayle, 1935 C.[D. 11, 453 O.G. 213.	
Disposition of Claims			
4) Claim(s) 1-33 is/are pending in the application	on.		
4a) Of the above claim(s) 5-11,14-27 and 30	0-33 is/are withdrawn from c	onsideration.	
5) Claim(s) is/are allowed.			
6) Claim(s) <u>1-4,12,13,28 and 29</u> is/are rejected	i .		
7) Claim(s) is/are objected to.	.,		
8) Claim(s) are subject to restriction and	a/or election requirement.		
Application Papers			
9) The specification is objected to by the Exam			
10)⊠ The drawing(s) filed on 14 April 2005 is/are:			
Applicant may not request that any objection to t	= : ,	* *	04(4)
Replacement drawing sheet(s) including the con	·		
•	Examiner. Note the attache	a Office Action of form 1 10-13.	- .
Priority under 35 U.S.C. § 119			
 12) Acknowledgment is made of a claim for fore a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 	ents have been received.		
3. Copies of the certified copies of the p		· · · · · · · · · · · · · · · · · · ·	,
application from the International Bur	-	Treceived in this National Stage	;
* See the attached detailed Office action for a		received.	
Attachment(s)			
1) X Notice of References Cited (PTO-892)		Summary (PTO-413)	
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No.	(s)/Mail Date Informal Patent Application (PTO-152)	
 Information Disclosure Statement(s) (PTO-1449 or PTO/SB/ Paper No(s)/Mail Date <u>04/14/05</u>. 	6) Other:		

DETAILED ACTION

Election/Restrictions

1. Applicant's election without traverse of Species A (Claims 1-4, 12, 13, 28 and 29) on 06/22/2005 is acknowledged.

Claims 5-11, 14-27 and 30-33 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected invention, there being no allowable generic or linking claim. Election was made without traverse in the reply filed on 06/22/2005.

Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-4, 12, 13, 28 and 29 are rejected under 35 U. S. C. 102(b) as being anticipated by Tan et al. (US Pat. 6,001,706, herein after Tan).

Regarding claims 1-4 and 28-29, Tan discloses a semiconductor device fabrication method comprising the steps of: polishing the surface of a film-to-be-polished 18 formed over a semiconductor substrate 10 by polishing slurry/CMP process (fig. 10A and col. 5, lines 53-62);

Art Unit: 2818

and after the surface of the film-to-be-polished 18 has been planarized, further polishing the surface of the film-to-be-polished 18 by polishing slurry/CMP process one more time (fig. 10B). Note that the CMP method is characterized by polishing a wafer surface with an abrasive cloth (pad) while supplying a polishing solution (slurry) mixed with abrasive grains. {See Koutny, Jr et al. (US 6,171,180) (col. 1, line 60 through col. 2, line 17 or Hsu et al. (US 6,677,239) (col. 1, lines 40-49; col. 10, lines 18-24 and Wang (US 6,046,112) (col. 6, lines 13-17)}.

Regarding claims 12 and 13, Tan discloses that before the step of planarizing the surface of the film-to-be-polished, the steps of forming over the semiconductor substrate 10 an insulation film (hard mask Si₃N₄ 14) having polish characteristics different from those of the film-to-be-polished (oxide 18); forming an opening in the insulation film 14; etching the semiconductor substrate 10 with the insulation film 14 as a mask to form a trench in the semiconductor substrate 10 (figs. 7 and 8A); and forming the film-to-be-polished 18 in the trench and over the insulation film 14 (fig. 9A), in the step of further polishing the surface of the film-to-be-polished, the surface of the film-to-be-polished 18 is polished with the insulation film 14 as a stopper (fig. 10A).

Conclusion

3. Any inquiry concerning this communication or earlier communications from the examiner should be directed to David Vu whose telephone number is (571) 272-1798. The examiner can normally be reached on Monday-Friday from 8:00am to 5:00pm. If attempt to

Art Unit: 2818

reach the examiner by telephone are unsuccessful, the examiner's supervisor, David Nelms can be reached on (571) 272-1787. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR, Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

David Vu

September 01, 2005.